

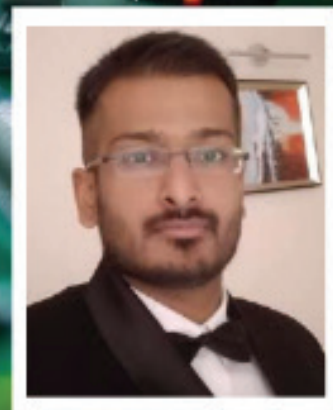
Electronics Era

A new era in technology media

Vol.-3 | Issue 6 | English | Monthly | Page 72

Cover Story

Advanced IC Packaging: Transforming India's Semiconductor Landscape



**Next-Level Application Efficiency
with Innovative MOSFET Technology**

**Revolutionizing Medical Electronics
with ANSYS Simulation Tools**

Saurabh Patawari
Managing Partner
National Electrical Equipments
Corporation (NEEC)



Transforming Electronics with IC Packaging Simulations: Latest Trends and How Ansys Leads the Way

By: Satish S | Technology Specialist in Electronics | CADFEM India